TOSHIBA Field-Effect Transistor Silicon P-Channel MOS Type (U-MOSVI)

SSM3J56MFV

Load Switching Applications

1.2 V drive

Low ON-resistance: $R_{DS(ON)}$ = 390 m Ω (max) (@V_{GS} = -4.5 V)

 $R_{DS(ON)} = 480 \text{ m}\Omega \text{ (max) (@V_{GS} = -2.5 V)}$ $R_{DS(ON)} = 660 \text{ m}\Omega \text{ (max) (@V_{GS} = -1.8 V)}$ $R_{DS(ON)} = 900 \text{ m}\Omega \text{ (max) (@V_{GS} = -1.5 V)}$ $R_{DS(ON)} = 4000 \text{ m}\Omega \text{ (max) (@V_{GS} = -1.2 V)}$

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol		Rating	Unit	
Drain-Source voltage		V_{DSS}		-20	V	
Gate-Source voltage		V _{GSS}		± 8	V	
Drain current	DC	ΙD	(Note 1)	-800	mA	
	Pulse	ΙD	P (Note 1)	-1600		
Power dissipation		P _D (Note 2)		150	mW	
		P _D (Note 3)		500		
			t < 5s	800		
Channel temperature		T _{ch}		150	°C	
Storage temperature range		T _{stg}		-55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: The channel temperature should not exceed 150°C during use.

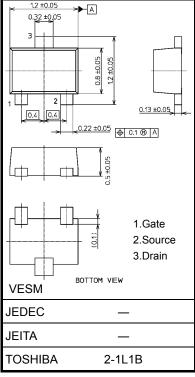
Note 2: Mounted on a FR4 board.

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{Cu Pad: } 0.585 \text{ mm}^2)$

Note 3: Mounted on a FR4 board.

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{Cu Pad: } 645 \text{ mm}^2)$

Unit: mm

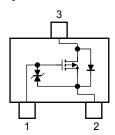


Weight: 1.5mg (typ.)

Marking

PW

Equivalent Circuit (top view)



Handling Precaution

When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

Thermal resistance Rth (ch-a) and Power dissipation PD vary depending on board material, board area, board thickness and pad area. When using this device, please take heat dissipation into consideration.

> Start of commercial production 2011-05

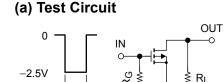
Electrical Characteristics (Ta = 25°C)

Chara	cteristic	Symbol	Test Conditions	Min	Тур.	Max	Unit
Drain-source breakdown voltage		V (BR) DSS	I _D = -1 mA, V _{GS} = 0 V	-20	_	_	V
		V (BR) DSX	$I_D = -1 \text{ mA}, V_{GS} = 5 \text{ V}$ (Note 5)	-15	_	_	V
Drain cut-off current		I _{DSS}	V _{DS} = -20 V, V _{GS} = 0 V	_	_	-1	μА
Gate leakage current		I _{GSS}	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±1	μА
Gate threshold voltage		V _{th}	$V_{DS} = -3 \text{ V}, I_{D} = -1 \text{ mA}$	-0.3	_	-1.0	V
Forward transfer admittance		Y _{fs}	$V_{DS} = -3 \text{ V}, I_D = -100 \text{ mA}$ (Note 4)	0.5	1.0	_	S
	R _{DS} (ON)	$I_D = -800 \text{ mA}, V_{GS} = -4.5 \text{ V}$ (Note 4)	_	310	390	mΩ	
		I_D = -500 mA, V_{GS} = -2.5 V (Note 4)	_	380	480		
Drain-source ON-resistance		$I_D = -200 \text{ mA}, V_{GS} = -1.8 \text{ V}$ (Note 4)	_	470	660		
		$I_D = -100 \text{ mA}, V_{GS} = -1.5 \text{ V}$ (Note 4)	_	560	900		
		$I_D = -10 \text{ mA}, V_{GS} = -1.2 \text{ V}$ (Note 4)	_	770	4000		
Input capacitance		C _{iss}		_	100	_	pF
Output capacitance		Coss	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	16	_	
Reverse transfer capacitance		C _{rss}		_	10	_	
Switching time	Turn-on time	t _{on}	V _{DD} = -10 V, I _D = -200 mA	_	8	_	ns
	Turn-off time	t _{off}	V_{GS} = 0 to -2.5 V, R_G = 50 Ω	_	26	_	
Total gate charge		Qg	V - 40 V I - 900 mA	_	1.6	_	nC
Gate-source charge		Q _{gs1}	$V_{DD} = -10 \text{ V}, I_D = -800 \text{ mA},$	_	0.2	_	
Gate-drain charge		Q _{gd}	$V_{GS} = -4.5 \text{ V}$	_	0.4	_	
Drain-source forward voltage		V _{DSF}	$I_D = 800 \text{ mA}, V_{GS} = 0 \text{ V}$ (Note 4)	_	0.9	1.2	V

Note 4: Pulse test

Note 5: If a forward bias is applied between gate and source, this device enters V(BR)DSX mode. Note that the drain-source breakdown voltage is lowered in this mode.

Switching Time Test Circuit



 V_{DD} = -10 V R_G = 50 Ω

Duty ≤ 1%

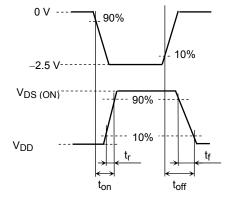
 $V_{IN}\text{: }t_{r},\,t_{f}<5\text{ ns}$

Common Source

 $Ta = 25^{\circ}C$



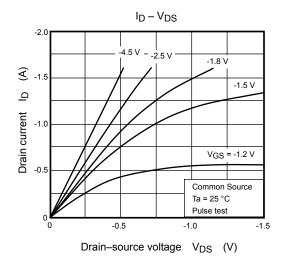
(c) Vout

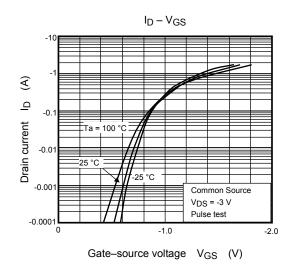


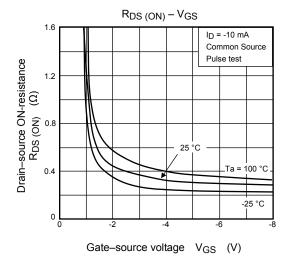
Notice on Usage

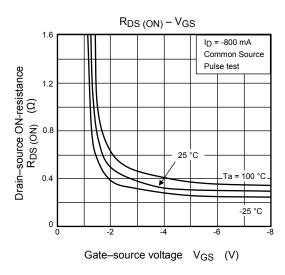
 V_{th} can be expressed as the voltage between gate and source when the low operating current value is I_D = -1 mA for this product. For normal switching operation, $V_{GS\ (on)}$ requires a higher voltage than V_{th} and $V_{GS\ (off)}$ requires a lower voltage than V_{th} . (The relationship can be established as follows: $V_{GS\ (off)} < V_{th} < V_{GS\ (on)}$.)

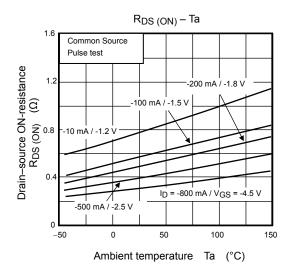
Take this into consideration when using the device.

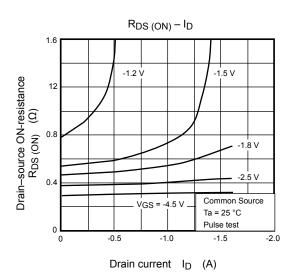


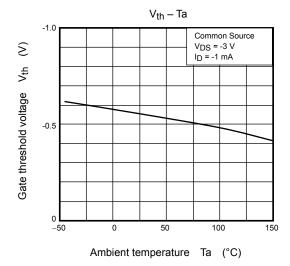


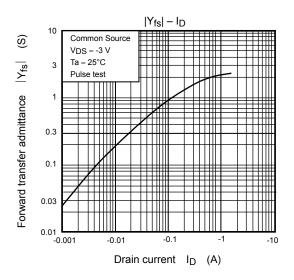


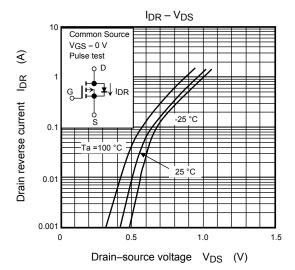


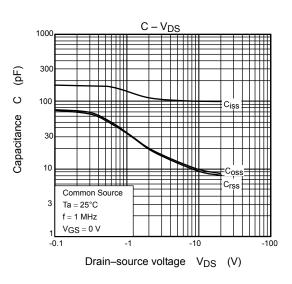


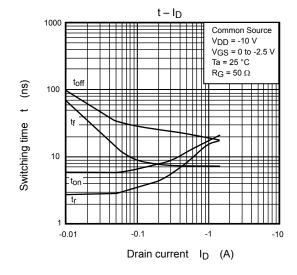


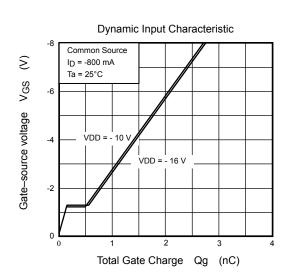


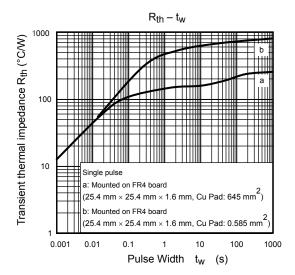


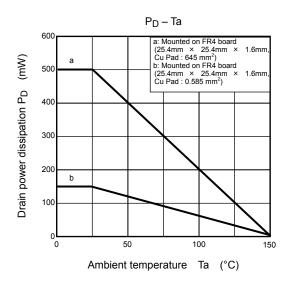












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